IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

1c560 U.S. PTO 09/128289

Application of:

William O. Burke, III et al.

Serial Number:

Unknown

Filed:

Herewith

Title:

FLOOR MAT EXHIBITING REDUCED RIPPLING EFFECTS AND IMPROVED DELAMINATING CHARACTERISTICS OF ITS TUFTED PILE FIBERS

Group Art Unit: Unknown Examiner: Unknown

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner of Patents Washington, DC 20231

Sir:

Under the provisions of 37 C.F.R. §1.97, et seq., including specifically subsections (g) and (h) thereof, Applicant(s) call to the attention of the Examiner the following documents:

- U. S. Patent 1,008,618 (Skowronski et al.)
- U. S. Patent 3,306,808 (Thompson et al.)
- U. S. Patent 4,045,605 (Breens et al.)
- U. S. Patent 4,353,944 (Tarui)
- U. S. Patent 4,447,201 (Knudsen)
- U. S. Patent 4,741,065 (Parkins)
- U. S. Patent 4,820,566 (Heine et al.)
- U. S. Patent 4,886,692 (Kerr et al.)
- U. S. Patent 5,055,333 (Heine et al.)
- U. S. Patent 5,154,961 (Reuben)

- U. S. Patent 5,227,214 (Kerr et al.)
- U. S. Patent 5,284,009 (Tung et al.)
- U. S. Patent 5,305,565 (Nagahama et al.)
- U. S. Patent 5,350,478 (Bojstrup et al.)
- U. S. Patent 5,680,826 (Nagahama et al.)

French Patent 1,211,755 (Cosyntex (S.A.))

Swiss Patent 614,853 (Peter Smith Associates et al.)

PCT Application WO95/30040 (Kleen-Tex Industries Inc.)

PCT Application WO96/37645 (Milliken Denmark)

Japanese Patent 2-112437 (Kanegafuchi Chem KK)

The above-listed references are provided for the examiner's review and entry in the record herein.

Respectfully submitted,

August 3, 1998

William S. Parks

Attorney for Applicant Registration No. 37,528

Telephone Number: (864) 503-1537

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service in an EXPRESS MAIL envelope bearing the Serial Number EL032034535US, and addressed to Commissioner of Patents, Washington, DC 20231, on August 3, 1998, along with 20 Patent documents, Form PTO-1449 (Modified), and a postcard receipt.

William S. Parks, Agent for Applicants